

R263-Z37-AAC1

Rack Server - 2U UP 12+2-Bay Gen5 NVMe/SATA/SAS-4 Platinum



Key Features

- Single AMD EPYC™ 9004 Series Processors
- 12-Channel DDR5 RDIMM, 12 x DIMMs
- Dual ROM Architecture
- 1 x 1Gb/s LAN port via Intel® I210-AT
- 4 x 3.5"/2.5" Gen5 NVMe/SATA/SAS-4 hot-swap bays
- 8 x 3.5"/2.5" SATA/SAS-4 hot-swap bays
- 2 x 2.5" Gen5 NVMe hot-swap bays on the rear side
- 1 x M.2 slot with PCIe Gen3 x4 interface
- 4 x FHHL PCIe Gen5 x16 slots
- 2 x OCP NIC 3.0 PCIe Gen5 x16 slots
- 1+1 1300W 80 PLUS Platinum redundant power supplies

Applications

Networks Server, Servers for Hybrid/Private Cloud...

Specification

Dimensions	2U (W438 x H87.5 x D710 mm)
Motherboard	MZ33-DC1
CPU	AMD EPYC™ 9005 Series Processors AMD EPYC™ 9004 Series Processors Single processor, cTDP up to 300W *cTDP supported up to 400W under limited thermal conditions.
OS Compatibility	OS Support List
Socket	1 x LGA 6096 (Socket SP5)
Chipset	System on Chip
Memory	12-Channel DDR5 RDIMM, 12 x DIMMs Up to 4800 MT/s
LAN	1 x 1Gb/s LAN (1 x Intel® I210-AT), Support NCSI 1 x 10/100/1000 Mbps Management LAN
Video	Integrated in ASPEED® AST2600 - 1 x Mini-DP
Storage	Front hot-swap: 4 x 3.5"/2.5" Gen5 NVMe/SATA/SAS-4 [1] 8 x 3.5"/2.5" SATA/SAS-4 [2] Rear hot-swap: 2 x 2.5" Gen5 NVMe [3] Internal M.2: 1 x M.2 (2280/22110), PCIe Gen3 x4 [1] Storage card is required to support SATA and SAS drives. [2] SAS card is required to support SAS drives. [3] NVMe supported only.
RAID	Require RAID add-in cards

PCIe Expansion Slots	4 x FHHL PCIe Gen5 x16 2 x OCP NIC 3.0 PCIe Gen5 x16, Support NCSI
I/O Ports	Front: 2 x USB 3.2 Gen1 Rear: 2 x USB 3.2 Gen1, 1 x Mini-DP, 1 x RJ45, 1 x MLAN
Backplane Board	Front - CBP20C7: PCIe Gen5 x4 or SATA 6Gb/s or SAS-4 24Gb/s Rear - CBP2025: PCIe Gen5 x4
TPM	1 x TPM header (SPI), Optional TPM2.0 kit: CTM010
Power Supply	1+1 1300W 80 PLUS Platinum redundant power supplies AC Input: 100-240V
System Management	ASPEED® AST2600 Baseboard Management Controller GIGABYTE Management Console web interface
System Fans	4 x 80x80x38mm
Operating Properties	Operating: 10°C to 35°C, 8% to 80% (non-condensing) Non-operating: -40°C to 60°C, 20% to 95% (non-condensing)
Packaging Content	1 x R263-Z37-AAC1 1 x CPU heatsink 1 x Mini-DP to D-Sub cable 1 x 2-Section Rail kit
Ordering Part Numbers	6NR263Z37DR000ABC1*
Optional Parts	- 3-Section Rail kit (Supports CMA): 25HB2-A56120-KOR - Cable Management Arm: 25HBZ-R18100-KOR



Learn more at: <https://www.gigabyte.com/Enterprise>

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